AS5047U

14-Bit On-Axis Magnetic Rotary Position Sensor with Up to 14-Bit Binary Incremental Pulse Count

General Description

The AS5047U is a high-resolution rotary position sensor for fast absolute angle measurement over a full 360-degree range. This new position sensor is equipped with a revolutionary integrated dynamic angle error compensation (DAEC[™]) with almost 0 latency at higher rotational speed. For increased signal quality at lower rotational speed, the dynamic filter system (DFS[™]) reduces transition noise.

The robust design of the device suppresses the influence of any homogenous external stray magnetic field. A standard 4-wire SPI serial interface with a CRC protection allows a host microcontroller to read 14-bit absolute angle position data from the AS5047U and to program non-volatile settings without a dedicated programmer.

Incremental movements are indicated on a set of ABI signals with a maximum resolution of 16989 steps / 4096 pulses per revolution.

Brushless DC (BLDC) motors are controlled through a standard UVW commutation interface with a programmable number of pole pairs from 1 to 7. The absolute angle position is also provided as PWM-encoded output signal.

AS5047U are single die sensors and are available in a TSSOP14 Package.

Ordering Information and Content Guide appear at end of datasheet.

Key Benefits & Features

The benefits and features of this device are listed below:

Figure 1: Added Value of Using the AS5047U

Benefits	Features
• Easy to use – saving costs on DSP	 DAEC [™] Dynamic angle error compensation DFS [™] Dynamic filter system
Higher durability and lower system costs (no shield needed)	Magnetic stray field immunity
Versatile choice of the interface	Independent output interfaces: SPI, ABI, UVW, PWM



Applications

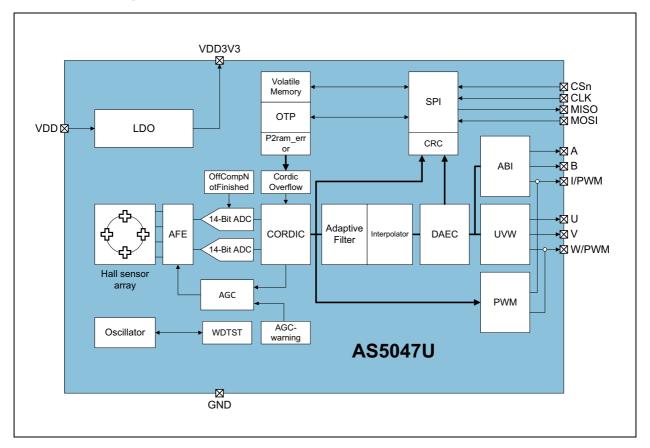
The AS5047U supports BLDC motor commutation for the most challenging industrial applications such as:

- Factory automation
- Building automation
- Robotics
- PMSM (permanent magnet synchronous motor)
- Stepper motor closed loop
- Optical encoder replacement

Block Diagram

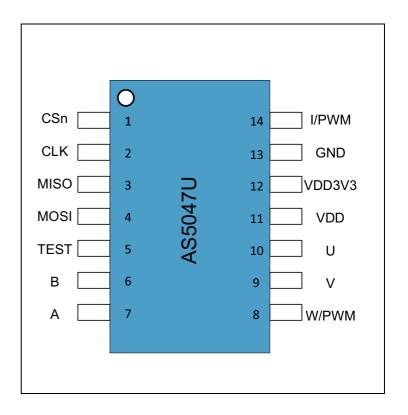
The functional blocks of the AS5047U are shown below:

Figure 2: AS5047U Block Diagram



Pin Assignment

Figure 3: TSSOP-14 Pin Assignment



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Figure 4: AS5047U Pin Description

Pin Number	Pin Name	Pin Type	Description
1	CSn	Digital input ⁽¹⁾	SPI chip select (active low) ⁽²⁾
2	CLK	Digital input ⁽¹⁾	SPI clock ⁽³⁾
3	MISO	Digital output	SPI master data input, slave output ⁽⁴⁾
4	MOSI	Digital input ⁽¹⁾	SPI master data output, slave input ⁽³⁾
5	TEST		Test pin (connect to ground)
6	В	Digital output	Incremental signal B ⁽⁵⁾
7	А	Digital output	Incremental signal A ⁽⁵⁾
8	W/PWM	Digital output	Commutation signal W or PWM-encoded output ⁽⁵⁾
9	V	Digital output	Commutation signal V ⁽⁵⁾
10	U	Digital output	Commutation signal U ⁽⁵⁾
11	VDD	Power supply	5V power supply voltage for on-chip regulator

Pin Number	Pin Name	Pin Type	Description
12	VDD3V3	Power supply	3.3V on-chip low-dropout (LDO) output. Requires an external decoupling capacitor (1µF)
13	GND	Power supply	Ground
14	I/PWM	Digital output	Incremental signal I (index) or PWM ⁽⁵⁾

Note(s):

1. Floating state of a digital input is not allowed.

2. If SPI is not used, a pull-up resistor on CSn is required.

3. If SPI is not used, a pull-down resistor on CLK and MOSI is required.

4. If SPI is not used, the pin MISO can be left open.

5. If ABI, UVW or PWM is not used, the pins can be left open.



Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated under Operational Conditions is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Figure 5: Absolute Maximum Ratings

Symbol	Parameter	Min	Max	Units	Comments		
Electrical Parameters							
VDD5	DC Supply Voltage at VDD pin	-0.3	7.0	V	Not operational		
VDD3	DC Supply Voltage at VDD3V3 pin	-0.3	5.0	V	Not operational		
V _{SS}	DC Supply Voltage at GND pin	-0.3	0.3	V			
V _{in}	Input Pin Voltage		VDD+0.3	V			
ا _{scr}	Input Current (latch-up immunity)	-100	100	mA	AEC-Q100-004		
	Το	tal Powe	er Dissipatio	n			
P _T	Total Power Dissipation (all supplies and outputs)		150	mW			
	El	ectrosta	tic Discharg	e			
ESD _{HBM}	Electrostatic Discharge HBM		±2	kV	AEC-Q100-002		
	Temperature	Ranges	and Storage	e Conditi	ons		
T _{AMB}	Operating Temperature Range	-40	150	°C	Ambient temperature		
T _{aProg}	Programming Temperature	5	45	°C	Programming @ room temperature (25°C ± 20°C)		
T _{STRG}	Storage Temperature Range	-55	150	°C			
T _{BODY}	Package Body Temperature		260	°C	IPC/JEDEC J-STD-020		
RH _{NC}	Relative Humidity (non-condensing)	5	85	%			
MSL	Moisture Sensitivity Level		3		Represents a maximum floor lifetime of 168h		



Electrical Characteristics

All in this datasheet defined tolerances for external components need to be assured over the whole operation conditions range and also over lifetime.

Overall condition: T_{AMB} = -40°C to 150°C components spec; unless otherwise noted.

Figure 6: Operational Conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Units
VDD5	Positive supply voltage	5.0V operation mode	4.5	5.0	5.5	V
VDD3V3	Positive supply voltage	3.3V operation mode; from -40°C to 150°C (NOISESET bit has to set)	3.0	3.3	3.6	v
VDD_Burn	Positive supply voltage	Supply voltage required for programming in 3.3V operation	3.3		3.5	V
V _{REG}	Regulated voltage	Voltage at VDD3V3 pin if VDD ≠ VDD3V3	3.2	3.4	3.6	V
I _{DD}	Supply current				16	mA
V _{IH}	High-level input voltage		0.7 × VDD			V
V _{IL}	Low-level input voltage				0.3 × VDD	V
V _{OH}	High-level output voltage		VDD - 0.5			V
V _{OL}	Low-level output voltage				V _{SS} + 0.4	V
C_L					50	pF
I_Out_5V	Output current 5 V operation ⁽¹⁾				4	mA
I_Out_3V	Output current 3 V operation ⁽¹⁾				2	mA

Note(s):

1. Only applicable for digital output pins I/PWM, A, B, U, V, W/PWM, MISO.

Magnetic Characteristics

Figure 7: Magnetic Characteristics

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Bz	Orthogonal Magnetic Field Strength	Required orthogonal component of the magnetic field strength measured at the die surface along a circle of 1.1mm radius	35		70	mT

Note(s):

1. All datasheet parameters are still valid as long as AGC (Automatic Gain Control) stays in range. To ensure a proper function of the AGC regulation loop, readout of ERRFL register (0x0001) or AGC register (0x3FF9) is required. Sensor can work with lower magnetic input field which influences spec parameters in terms of noise and accuracy. In case the sensor will be used in application with wider z distance, please contact the support team for detailed information.

System Specifications

Figure 8: System Specifications

Symbol	Parameter	Conditions	Min	Тур	Мах	Units
RES	Core and resolution on SPI			14		bit
RES_ABI	Resolution of the ABI interface	Programmable with register setting (ABIRES)	25		4096	steps
INL _{OPT} @ 25°C	Non-linearity, optimum placement of the magnet			±0.4	±0.8	degree
INL _{OPT+TEMP}	Non-linearity, optimum placement of magnet and temperature -40°C to 150°C			±0.6	±1	degree
INL _{DIS+TEMP}	Non-linearity @ displacement of magnet and temperature -40°C to 150°C	Assuming N35H Magnet (D=8mm, H=3mm) 500μm displacement in x and y z-distance = 2000μm			±1.2	degree
ONL	RMS output noise without filter (1 sigma) on SPI, ABI, PWM and UVW. Not tested, guaranteed by design	Orthogonal component for the magnetic field within the specified range (Bz), NOISESET= 0		0.034	0.068	degree

Symbol	Parameter	Conditions	Min	Тур	Max	Units
ONH	RMS output noise without filter (1 sigma) on SPI, ABI, PWM and UVW. Not tested, guaranteed by design	Orthogonal component for the magnetic field within the specified range (Bz), NOISESET = 1		0.041	0.082	degree
t _{delay}	System propagation delay –core	Reading angle via SPI	90		110	μs
t _{delay_} DAEC	Residual system propagation delay after dynamic angle error correction	At ABI, UVW and SPI	-1.9		1.9	μs
t _{refresh}	Refresh time of DAEC output	Refresh time at SPI(ANGLECOM), ABI, UVW	202	222	247	ns
DAE ₁₇₀₀	Dynamic angle error	At 1700 rpm constant speed			0.02	degree
DAE _{max}	Dynamic angle error	At 28000 rpm constant speed			0.32	degree
MS	Maximum speed				28000	rpm

Reference magnet: N35H, 8mm diameter; 3mm thickness. Magnet in the Bz range.



Timing Characteristics

Figure 9: Timing Specifications

Symbo	ol Parameter	Conditions	Min	Тур	Max	Units
t _{pon}	Power-on time	Guaranteed by design. Time between VDD > VDD _{min} and the first valid outcome			10	ms

Detailed Description

The AS5047U is a Hall-effect magnetic sensor using a CMOS technology. The Hall sensors convert the magnetic field component perpendicular to the surface of the chip into voltage.

The signals from the Hall sensors are amplified and filtered by the analog front-end (AFE) before being converted by the analog-to-digital converter (ADC). The output of the ADC is processed by the hardwired CORDIC (coordinate rotation digital computer) block to compute the angle and magnitude of the magnetic vector. The intensity of the magnetic field (magnitude) used by the automatic gain control (AGC) to adjust the amplification level for compensation of the temperature and magnetic field variations.

The AS5047U generates continuously the angle information, which can be requested by the different interfaces of the device. The internal 14-bit resolution is available by readout register via the SPI interface. The resolution on the ABI output can be programmed for 10 to 14 bits.

The Dynamic Angle Error Compensation block corrects the calculated angle regarding latency by using a linear prediction calculation algorithm. At constant rotation speed the latency time is internally compensated by the AS5047U, reducing the dynamic angle error at the SPI, ABI and UVW outputs.

The adaptive filter block is implemented after the compensation block and reduces the transition noise at low rotation speed. The stable information is available on SPI, ABI and UVW.

AS5047U allows selecting between a UVW output interface and a PWM encoded interface on the W pin.

The non-volatile settings in the AS5047U is programmed through the SPI interface without any dedicated programmer.

The AS5047U can support high-speed application up to 28krpm.



Power Management

The AS5047U can be either powered from a 5.0V supply using the on-chip low-dropout regulator or from a 3.3V voltage supply. The LDO regulator is not intended to power any other loads, and it needs a 1 μ F capacitor to ground located close to chip for decoupling as shown in Figure 11.

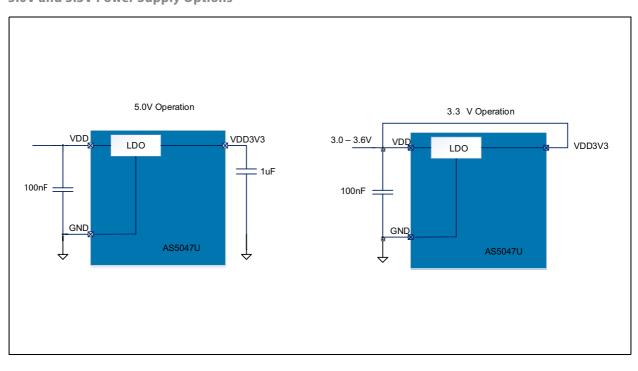
In 3.3.V operation, VDD and VREG shall connected together. In this configuration, normal noise performance (ONL) is available at reduced maximum temperature (125°C) by clearing NOISESET to 0. When NOISESET is set to 1, the full temperature range is available with reduced noise performance (ONH).

Figure 10:

Temperature Range and Output Noise Without Filtering in 3.3V and 5.0V Mode

VDD (V)	NOISESET	Temperature Range (°C)	RMS Output Noise (degree)
5.0	0	-40 to 150	0.068
3.3	0	-40 to 125	0.068
3.3	1	-40 to 150	0.082

Figure 11: 5.0V and 3.3V Power Supply Options



Dynamic Angle Error Compensation

The AS5047U uses 4 integrated Hall sensors which produce a voltage proportional to the orthogonal component of the magnetic field to the die. These voltage signals are amplified, filtered, and converted into the digital domain to allow the CORDIC digital block to calculate the angle of the magnetic vector. The propagation of these signals through the analog front-end and digital back-end generates a fixed delay between the time of measurement and the availability of the measured angle at the outputs. This latency generates a dynamic angle error represented by the product of the angular speed (ω) and the system propagation delay (t_{delay}):

(EQ1) $DAE = \omega x t_{delay}$

The dynamic angle compensation block calculates the current magnet rotation speed (ω) and multiplies it with the system propagation delay (t_{delay}) to determine the correction angle to reduce this error. At constant speed, the residual system propagation delay is t_{delay_DAEC}.

The angle represented on the PWM interface is not compensated by the Dynamic Angle Error Compensation algorithm. It is also possible to disable the Dynamic Angle Error Compensation with the DAECDIS setting. Disabling the Dynamic Angle Error Compensation gives a noise benefit of 0.016 degree rms. This setting can be advantageous for low speed (under 100 RPM) respectively static positioning applications.

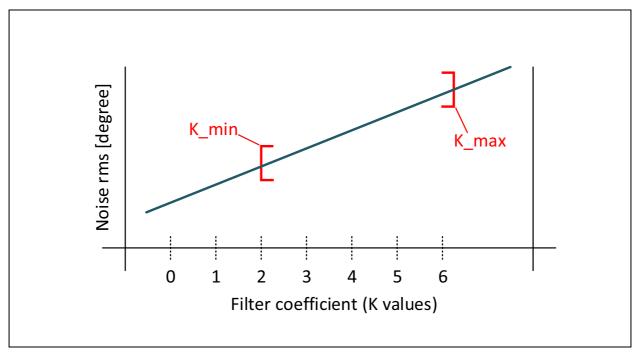
Adaptive Filter System

The AS5047U uses an implemented adaptive filter system, which reduces the transition noise.

The filter works dynamically depending on acceleration (positive and negative acceleration) of rotating system. It is able to match the right filter coefficients automatically.

The filter coefficients (K value), which define also the limits in which the filters is acting, can be set in the OTP (K_min= 0x00 and K_max=0x00 by default).In addition, there is the possibility to turn off the filter in the OTP.





For detailed application information please refer to the Application Note: AS5x47U_Adaptive_Filter.

Figure 13: K Value Configuration

K_min [LSB]	Minimum K Value	K_max [LSB]	Maximum K Value
000	2	000	6
001	3	001	5
010	4	010	4
011	5	011	3
100	6	100	5
101	0	101	1
110	1	110	0
111	1	111	0

Figure 14:

3			
Adaptive	Filter	System	Setting

Symbol	Parameter	Min	Тур	Max	Unit	Notes
fcorner	Corner frequency	48		3059	Hz	Depending on K setting in the OTP
ONFdyn	Noise during rotation	0.019		0.086	o	RMS noise (depending on the selected K setting)
ONFstat	Noise when stand still	0.011		0.084	o	Depending on K setting in the OTP

Figure 15:

Corner Frequency vs Noise

K Value	fcorner Filter corner frequency [Hz]	ONFdyn Noise during rotation [degree]	ONFstat Noise when stand still [degree]
0	48	0.019	0.011
1	97	0.028	0.017
2	194	0.036	0.032
3	387	0.048	0.044
4	773	0.062	0.059
5	1548	0.077	0.077
6	3095	0.086	0.084

Speed Measurements

Rotation Speed Measurement

The AS5047U features an average angular velocity calculation algorithm with 14-bit resolution. This angular velocity information is available over SPI and can be used without further averaging in the ECU.

Figure 16: Angular Velocity Measurement Parameter

Symbol	Parameter	Min	Тур	Мах	Unit	Notes
V _{Res}	Velocity signal resolution		14		bit	Two's complement value
V _{Range}	Measurement range (default)	-28000		28000	rpm	
V _{Sens}	Velocity sensitivity (default)		24.141		°/s/bit	14-bit resolution
V _{Error}	Velocity total error			±5	%	Based on actual rotation speed
F _{Cutoff}	Cut off frequency	16.9	68.4	231	Hz	Depending on K value (see adaptive filter system)

Figure 17:

Angular Velocity Measurement Filter Parameters

Filter Setting	Тур	Unit	Notes
K=0	5.8		
K=1	6		
K=2	8.4		
K=3	19.8	°/s	RMS noise
K=4	51.8		
K=5	121.9		
K=6	244.9		



SPI Interface (Slave)

The SPI interface shall connected to a host microcontroller (master) to read or write the volatile memory as well as to program the non-volatile OTP registers.

The AS5047U SPI only supports slave operation mode. It communicates at clock rates up to 10 MHz.

The AS5047U SPI uses mode=1 (CPOL=0, CPHA=1) to exchange data. As shown in Figure 18, a data transfer starts with the falling edge of CSn (CLK is low). The AS5047U samples MOSI data on the falling edge of CLK. SPI commands are executed at the end of the frame (rising edge of CSn). The bit order is MSB first.

A CRC is protecting the SPI Data.

SPI Timing

The AS5047U SPI timing is shown in Figure 18.



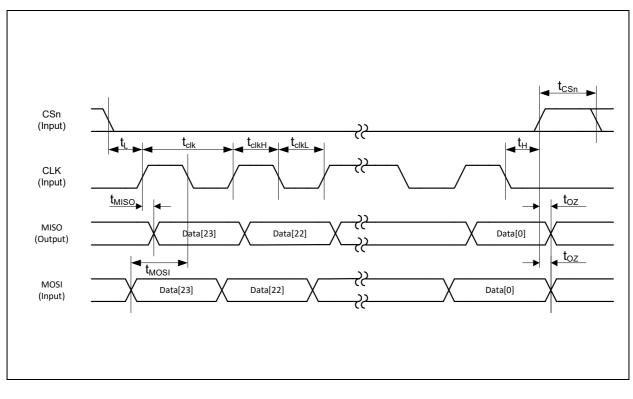


Figure 19: SPI Timing

Parameter	Description	Min	Мах	Units
tL	Time between CSn falling edge and CLK rising edge	350 ⁽¹⁾		ns
t _{clk}	Serial clock period	100		ns
t _{clkL}	Low period of serial clock	50		ns
t _{clkH}	High period of serial clock	50		ns
t _H	Time between last falling edge of CLK and rising edge of CSn	t _{clk/2}		ns
t _{CSn}	High time of SS/ between two transmissions	350 ⁽¹⁾		ns
t _{MOSI}	Data input valid to clock edge	20		ns
t _{MISO}	CLK edge to data output valid		51	ns
t _{OZ}	Time between CSn rising edge and MISO HiZ		10	ns

Note(s):

1. Synchronization with the internal clock \rightarrow 2 * t_{CLK_SYS} + 10ns (t_{CLK_SYS} is 9MHz typ).



SPI Transaction

AS5047U provides two different SPI transactions

- 16-bit SPI frame without CRC (for high throughput)
- 24-bit SPI frames with CRC
- 32-bit SPI frames with CRC. The 32-bit SPI frames includes 8-bit PAD word.

For high-throughput requirements, the AS5047U can handle 16-bit frames for read operations. This allows reading more than 400000 angle positions per second.

Figure 20: 16-Bit SPI Frame

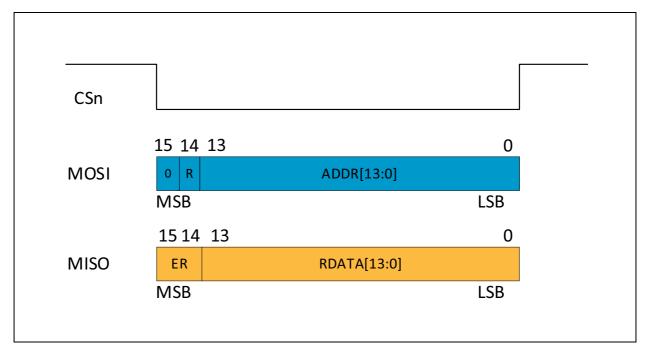


Figure 21: 16-Bit Command Frame

Bit	Name	Description
15	0	Do not Care
14	R	1: Read
13:0	ADDR[13:0]	Address

Figure 22: 16-Bit Data Frame

Bit	Name	Description
15	ER -	Warning Bit
14		Error Bit
13:0	DATA[13:0]	Data

24-Bit SPI frames and 32-Bit SPI frames have CRC for increased reliability of communication over the SPI. A wrong setting of the calculation / setting of the CRC causes a CRC error, which sets the CRCERR bit in the error flag register.



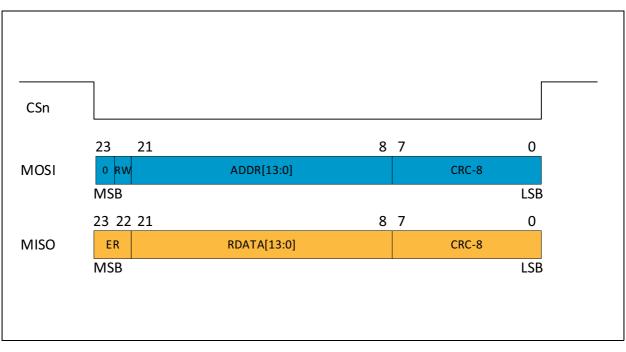


Figure 24: 24-Bit Command Frame

Bit	Name	Description
23	0	Do not Care
22	RW	0: Write 1: Read
21:8	ADDR[13:0]	Address
7:0	CRC	Calculated CRC



Figure 25: 24-Bit Data Frame

Bit	Name	Description
23	ER	Warning Bit
22		Error Bit
21:8	DATA[13:0]	Data
7:0	CRC	Calculated CRC

The 32-Bit Frames have a PAD Word, which is applicable for operation in daisy chain mode.



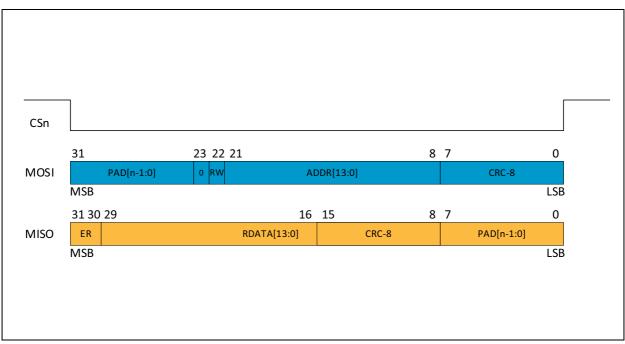


Figure 27: 32-Bit Command Frame

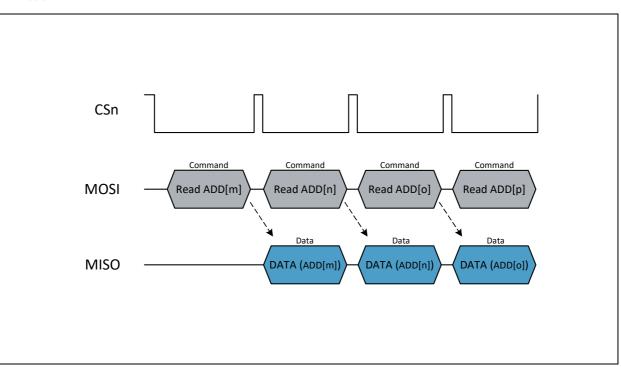
Bit	Name	Description
31:24	PAD	PAD Number
23	0	Do Not care
22	RW	0: Write 1: Read
21:8	ADDR[13:0]	Address
7:0	CRC	Calculated CRC

Figure 28: 32-Bit Data Frame

Bit	Name	Description
31	ER	Warning Bit
30	LIN	Error Bit
29:16	RW	Data
15:8	ADDR[13:0]	Calculated CRC
7:0	CRC	PAD Number

The data sent on the MISO pin. The CRC is calculated by the AS5047U. If an error or a warning is detected in the previous SPI command frame, the Error/Warning bit is set high. The SPI read is synchronized on the rising edge of CSn and the data is transmitted on MISO with the next read command, as shown in Figure 29.



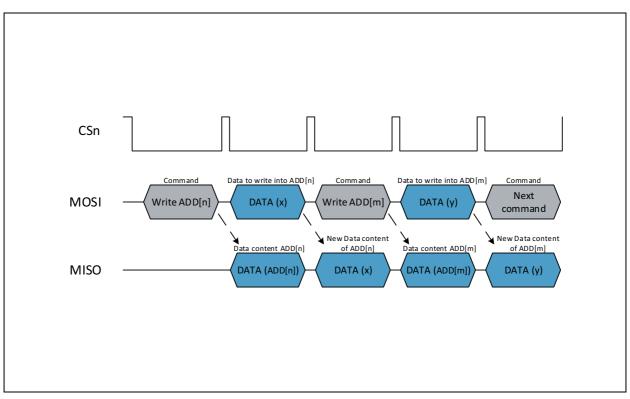


Recommended CRC calculation see chapter CRC Checksum

In an SPI write transaction, the write command frame is followed by a write data frame at MOSI. The write data frame consists of the new content of register which address is in the command frame. During the new content is transmitted on MOSI by the write data frame, the old content is send on MISO. At the next command on MOSI the actual content of the register is transmitted on MISO, as shown in Figure 30.



Figure 30: SPI Write



PAD Word

Any number of PAD [8*n-1:0] bits can precede the MOSI data. The PAD word is used to allocate the data on MISO to the correct device.



CRC Checksum

For secure and reliable data transmission, the 24-bit and 32-bit frames have a CRC for verification of correct transmission. The CRC is calculated out of the payload of the SPI frame.

For the 24-bit SPI frames, the CRC calculation is based on bits 23:8. For the 32-bit command frame (MOSI), the CRC calculation is based on bits 23:8 as well. For the 32-bit data frame (MISO), the CRC is calculated based on bits 31:16. The PAD Number in the 32-bit frame does not affect the CRC.

The calculation of the CRC is based on Irreducible polynomial $x^{4}+x^{3}+x^{2}+1$.

The initialization CRC = 0xC4 prevents that 0x000000 is a valid SPI command. This command would clear all sticky error flags.

Figure 31: CRC Parameters

Name	Value
CRC width	8-bit
Polynomial	0x1D
Initial value	0xC4
Input reflected	No
Result reflected	No
Final XOR value	0xFF



Volatile Registers

The volatile registers are shown in Figure 32. Each register has a 14-bit address.

Figure 32: Volatile Memory Register Description

Address	Name	Default	Description
0x0000	NOP	0x0000	No operation
0x0001	ERRFL	0x0000	Error register
0x0003	PROG	0x0000	Programming register
0x3FF5	DIA	0xX3C2 or 0xXBC2 for 3.3V mode 0xX3C3 or 0xXBC3 for 5 V mode	DIAGNOSTIC
0x3FF9	AGC	0x0000	AGC Value
0x3FFA	Sin-data	0x0000	Raw digital sine channel data
0x3FFB	Cos-data	0x0000	Raw digital cosine channel data
0x3FFC	VEL	0x0000	Velocity
0x3FFD	MAG	0x0000	CORDIC magnitude
0x3FFE	ANGLEUNC	0x0000	Measured angle without dynamic angle error compensation
0x3FFF	ANGLECOM	0x0000	Measured angle with dynamic angle error compensation
0x00D1	ECC_Checksum	0x0000	ECC checksum calculated based on actual register setting

Figure 33: ERRFL (0x0001)

Name	Read/Write	Bit Position	Description
CORDIC Overflow	R	10	Reading the Overflow Bit of the CORDIC
OffCompNotFi nished	R	9	In case the flag is 1 the internal offset compensation is not finished
Not used	N/A	8	No function. Bit Setting: 0
WDTST	R	7	Watchdog information . In case the flag sets to 1, the internal oscillator or the watchdog is not working correctly
CRC error	R	6	CRC error during SPI communication

Name	Read/Write	Bit Position	Description
Command_ error	R	5	SPI invalid command received
Framing error	R	4	Framing if SPI communication wrong
P2ram_error	R	3	ECC has detected 2 uncorrectable errors in P2RAM in customer area
P2ram_ warning	R	2	ECC is correcting one bit of P2RAM in customer area
MagHalf	R	1	This flag sets to 1 in case the AGC Value reaches 255 LSB and the magnitude value is the half of the of the regulated magnitude value (between AGC = 0LSB and AGC = 255LSB) which is typical 4800LSB.
Agc-warning	R	0	Agc-warning=1. The flag sets to 1 in case the AGC Value reaches 0LSB or 255LSB. The detailed information which level is reached can be found in the diagnostic register.

Reading the ERRFL register automatically clears its contents (ERRFL=0x0000).

In case of an error flag, a read of the DIA register is mandatory.

Figure 34: PROG (0x0003)

Name	Read/Write	Bit Position	Description
PROGVER	R/W	6	Program verify: Must be set to 1 for verifying the correctness of the OTP programming
PROGOTP	R/W	3	Start OTP programming cycle
OTPREF	R/W	2	Refreshes the non-volatile memory content with the OTP programmed content
PROGEN	R/W	0	Program OTP enable: Enables reading / writing the OTP memory

The PROG register is used for programming the OTP memory.

Figure 35: DIA(0x3FF5)

Name	Read/Write	Bit Position	Description
SPI_cnt	R	11:12	SPI frame counter
Not used	N/A	10	No function. Bit Setting: 0
AGC_finished	R	9	Initial AGC settling finished
Off comp finished	R	8	Error flag offset compensation finished
SinOff_fin	R	7	Sine offset compensation finished
CosOff_fin	R	6	Cosine offset compensation finished
MagHalf_flag	R	5	Error flag magnitude is below half of target value
Comp_h	R	4	Warning flag AGC high
Comp_l	R	3	Warning flag AGC low
Cordic_overflow	R	2	Error flag CORDIC overflow
LoopsFinished	R	1	All Magneto Core loops finished
Vdd_mode	R	0	VDD supply mode: 0: VDD 3.3 Mode 1: VDD 5.0 Mode

Figure 36: AGC(0x3FF9)

Name	Read/Write	Bit Position	Description
AGC	R	7:0	8-Bit AGC value

Figure 37: VEL(0x3FFC)

Name	Read/Write	Bit Position	Description
Vel	R	13:0	Velocity value (14-bit signed integer)

Figure 38: MAG (0x3FFD)

Name	Read/Write	Bit Position	Description
Mag	R	13:0	CORDIC magnitude information



Figure 39: ANGLEUNC (0x3FFE)

Name	Read/Write	Bit Position	Description
ANGLEUNC	R	13:0	Angle information without dynamic angle error compensation

Figure 40: ECC_s (0x3FD0)

Name	Read/Write	Bit Position	Description
ECC_s	R	6:0	Calculated ECC checksum

Figure 41: ANGLECOM(0x3FFF)

Name	Read/Write	Bit Position	Description
ANGLECOM	I R	13:0	Angle information with dynamic angle error compensation

Non-Volatile Registers (OTP)

The OTP (One-Time Programmable) memory is used to store the absolute zero position of the sensor and the customer settings permanently in the sensor IC. SPI write/read access is possible several times for all non-volatile registers (soft write). Soft written register content will be lost after a hardware reset. The programming itself can be done just once. Therefore the content of the non-volatile registers is stored permanently in the sensor. The register content is still present after a hardware reset and cannot be overwritten. For a correct function of the sensor the OTP programming is not required. If no configuration or programming is done, the non-volatile registers are in the default state 0x0000.

Figure 42: Non-Volatile Register Table

Address	Name	Default	Description
0x0015	DISABLE	0x0000	Outputs and filter disable register
0x0016	ZPOSM	0x0000	Zero position MSB
0x0017	ZPOSL	0x0000	Zero position LSB/ MAG diagnostic
0x0018	SETTINGS1	0x0000	Custom setting register 1

Address	Name	Default	Description
0x0019	SETTINGS2	0x0000	Custom setting register 2
0x001A	SETTINGS3	0x0000	Custom setting register 3
0x001B	ECC	0x0000	ECC Settings

Figure 43: DISABLE (0x0015)

Name	Read/Write/Program	Bit Position	Description
UVW_off	RW	0	0: Normal mode (default) 1: Switch UVW output off (tristate)
ABI_off	RW	1	0: Normal mode (default) 1: Switch ABI output off (tristate)
na	RW	2:5	Default=0
FILTER_disable	RW	6	0: Filter enabled (default) 1: Filter disabled

Figure 44: ZPOSM (0x0016)

Name	Read/Write/Program	Bit Position	Description
ZPOSM	R/W/P	7:0	8 most significant bits of the zero position

Figure 45: ZPOSL (0x0017)

Name	Read/Write/Program	Bit Position	Description
ZPOSL	R/W/P	5:0	6 least significant bits of the zero position
Dia1_en	R/W/P	6	Default=0; only applicable for automotive version AS5147U
Dia2_en	R/W/P	7	Default=0; only applicable for automotive version AS5147U



Figure 46: SETTINGS1 (0x0018)

Name	Read/Write/Program	Bit Position	Description
K_max	R/W/P	2:0	K max for adaptive filter setting
K_min	R/W/P	5:3	K min for adaptive filter setting
Dia3_en	R/W/P	6	Default=0; not applicable
Dia4_en	R/W/P	7	Default=0; not applicable

Figure 47: SETTINGS2 (0x0019)

Name	Read/Write/Program	Bit Position	Description	
IWIDTH	R/W/P	0	0: 3 pulses 1: 1 pulses	
NOISESET	R/W/P	1	Noise setting for 3.3V operation at 150°C	
DIR	R/W/P	2	Rotation direction	
UVW_ABI	R/W/P	3	Defines the PWM output (0=ABI is operating, W is used as PWM) (1=UVW is operating, I is used as PWM)	
DAECDIS	R/W/P	Disable dynamic angle error compensatio 4 (0=DAE compensation ON, 1=DAE compensation OFF)		
ABI_DEC	R/W/P	5	ABI setting to decimal count	
Data_select	R/W/P	6	This bit defines which data can be read from address 16383dec (3FFFhex) 0-> ANGLECOM 1-> ANGLEUNC	
PWMon	R/W/P	7 Enables PWM (setting of UVW_ABI bit necessary)		



Figure 48: SETTINGS3 (0x001A)

Name	Read/Write/Program	Bit Position	Description	
UVWPP	R/W/P	2:0	UVW number of pole pairs	
HYS	R/W/P	4:3	Hysteresis	
ABIRES	R/W/P	7:5	Resolution of ABI	

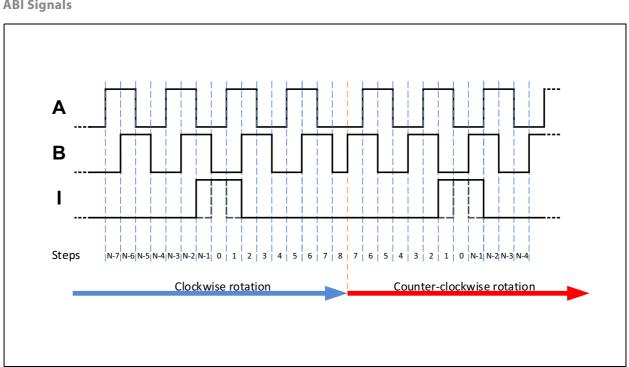
Figure 49: ECC (0x001B)

Name	Read/Write/ Program	Bit Position	Description
ECC_chsum	R/W/P	6:0	ECC checksum
ECC_en	R/W/P	7	Enables ECC

ABI Incremental Interface

The AS5047U can send the angle position to the host microcontroller through an incremental interface. This interface is available simultaneously with the other interfaces. By default, the incremental interface is set to work at a 12-bit resolution which corresponds to 4096 steps per revolution or 1024 pulses per revolution (ppr). This resolution can be changed with the OTP bits ABIRES. The phase shift between the A and B signals indicates the rotation direction: clockwise (A leads, B follows) or counterclockwise (B leads, A follows). During the start-up time, after power on to the chip, all three ABI signals are high. The DIR bit can be used to invert the sense of the rotation direction.

The IWIDTH setting programs the width of the index pulse from 3 LSB (default) to 1 LSB.



N= 16384 for 14-Bit resolution, N = 4096 for 12-bit resolution and N = 1024 for 10-bit resolution..

The Figure 50 shows the ABI signal flow if the magnet rotates in clockwise direction and counter-clockwise direction (DIR=0).

The rotation direction of the magnet is defined as clockwise (DIR=0) when the view is from the topside of AS5047U.

Figure 50: **ABI Signals**



Figure 51: ABI Settings

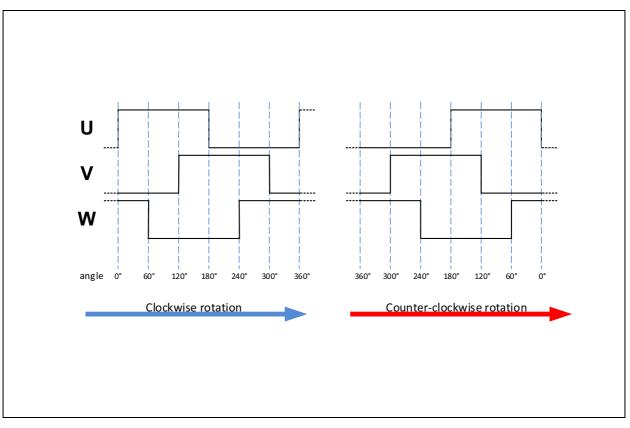
ABIRES [LSB] SETTINGS3 (0x001A)	ABI_DEC SETTINGS2 (0x0019)	ABI_Pulses	ABI Resolution [LSB]
100	0	4096	16384
011	0	2048	8192
000	0	1024	4096 (default value)
001	0	512	2048
010	0	256	1024
000	1	1000	4000
001	1	500	2000
010	1	400	1600
011	1	300	1200
100	1	200	800
101	1	100	400
110	1	50	200
111	1	25	100

UVW Commutation Interface

The AS5047U can emulate the UVW signals generated by the three discrete Hall switches commonly used in BLDC motors. The UVWPP field in the SETTINGS3 register selects the number of pole pairs of the motor (from 1 to 7 pole pairs). The UVW signals are generated based on 14-bit core resolution.

During the start-up time, after power on of the chip, the UVW signals are low.





The Figure 52 shows the UVW signal flow if the magnet rotates in clockwise direction and counter-clockwise direction (DIR=0). The rotation direction of the magnet is defined as clockwise (DIR=0) when the view is from the topside of AS5047U. With the bit DIR, it is possible to invert the rotation direction.



Figure 53: UVW Settings

UVWPP [LSB]	Pole Pairs
000	1pp (default)
001	2рр
010	Зрр
011	4рр
100	5рр
101	брр
110	7рр
111	7рр



PWM

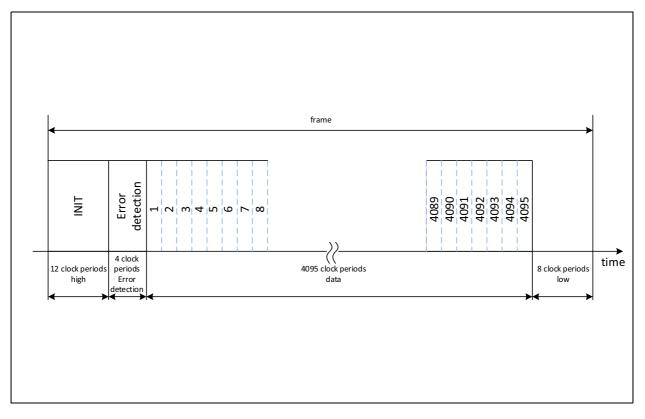
The PWM can be enabled with the bit setting PWMon. The PWM encoded signal is displayed on the pin W or the pin I. The bit setting UVW_ABI defines which output is used as PWM. The PWM output consists of a frame of 4119 PWM clock periods, as shown in Figure 54. The PWM frame has the following sections:

- 12 PWM clock periods for INIT
- 4 PWM clock periods for error detection
- 4095 PWM clock periods of data
- 8 PWM clock periods low

The angle is represented in the data part of the frame with a 12-bit resolution. One PWM clock period represents 0.088 degree and has a typical duration of 444 ns.

If the embedded diagnostic of the AS5047U detects any error the PWM interface displays only 12 clock periods high (0.3% duty-cycle). Respectively the 4 clocks for error detection are forced to low.

Figure 54: Pulse Width Modulation Encoded Signal



Hysteresis

Incremental Output Hysteresis

A hysteresis is introduced to avoid flickering at incremental outputs at a stationary magnet position. In case of a rotational direction change, the incremental outputs have a hysteresis, which can be set in the SETTINGS3 register by HYSt-bits.

Regardless of the programmed incremental resolution, the hysteresis always corresponds to the highest resolution of 11-bit

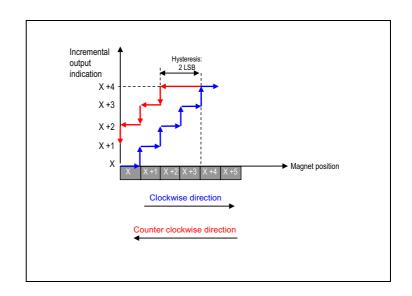
Figure 55: Hysteresis Settings

HYS	Hysteresis LSB	Hysteresis Degree	
00	1	0.17°	Default
01	2	0.35°	
10	3	0.52°	
11	0	0	

For constant rotational directions, every magnet position change is indicated at the incremental outputs (see Figure 56). If for example the magnet turns clockwise from position "x+3" to "x+4", the incremental output would also indicate this position accordingly.

A change of the magnet's rotational direction back to position "x+3"means, that the incremental output still remains unchanged for the duration of 2 LSB, until position "x+2" is reached. Following this direction, the incremental outputs will again be updated with every change of the magnet position.

Figure 56: Hysteresis



Automatic Gain Control (AGC) and CORDIC Magnitude

The AS5047U uses AGC to compensate for variations in the magnetic field strength due to changes of temperature, air gap between the chip and the magnet, and demagnetization of the magnet. The automatic gain control value can be read in the AGC field of the AGC register. Within the specified input magnetic field strength (Bz), the Automatic Gain Control keeps the CORDIC magnitude value (MAG) constant. If magnetic field strength is out of specifications, the AGC has its limits reached and the Agc-warning bit is set. When the magnetic field strength is decreasing more then AGC can control, the CORDIC magnitude is also decreasing.

If the CORDIC magnitude decreases lower than half of the target magnet, the error flag MagHalf_flag is set.

ECC

The ECC (Error Code Correction) is a mechanism which protects the customer settings.

The ECC protection is active whenever ECC_en=1. ECC_en is the error corrected counterpart of the P2RAM bit en and is found in register ECC_STATUS. Whenever a bit error occurs, this is reported by the status register ERRFL [2:3]. Single bit errors are corrected immediately and do not influence the correct operation of the sensor. If either a single or double errors are detected, the next SPI MISO frame will report this to the software by setting flags error=1 (double bit error) or warning=1 (single bit error). Warning and error are sticky flags, which guarantees that spurious P2RAM errors are certainly reported.

The ECC Protection is activated with the following steps:

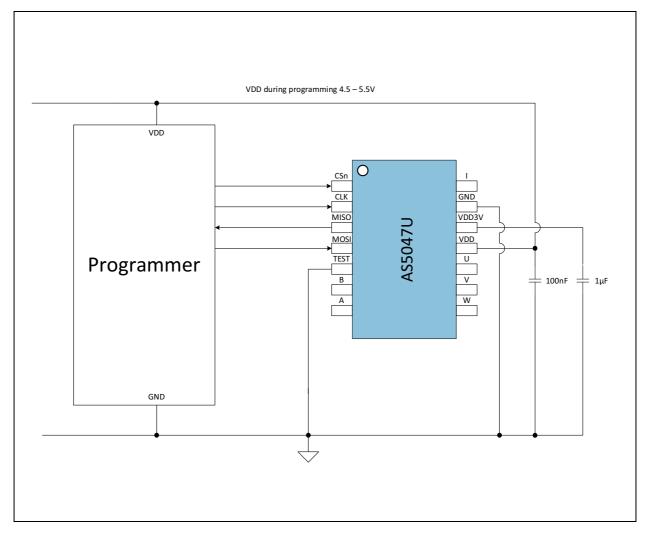
- Writing uses data into the register and set ECC_en to high.
- Reading ECC_s from register 0x3FD0 and set the value into ECC_chsum. Do not overwrite the ECC_en
- Programming the part.



Application Information

Burn and Verification of the OTP Memory

Figure 57: Minimum Programming Diagram for the AS5047U with 5V Supply Voltage



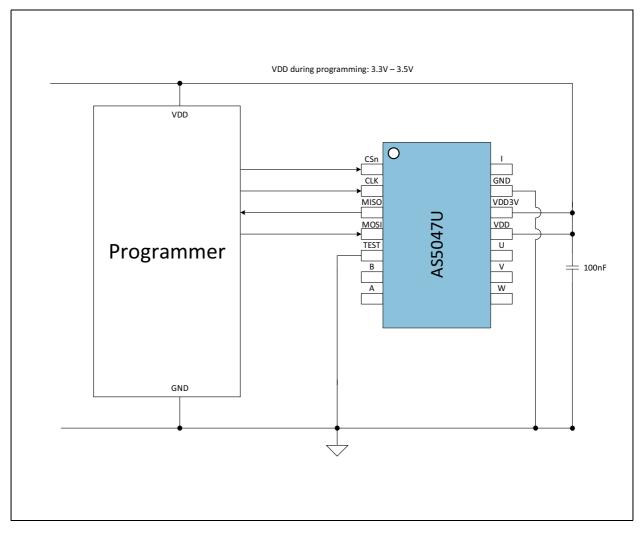
Note(s):

1. In terms of EMC and for remote application, additional circuits are necessary.



Figure 58:

Minimum Programming Diagram for the AS5047U with 3.3V Supply Voltage



Note(s):

1. In terms of EMC and for remote application, additional circuits are necessary.

Figure 59: Programming Parameter

Symbol	Parameter	Conditions	Min	Тур	Max	Units
T _{aProg}	Programming temperature	Programming @ Room Temperature (25°C ± 20°C)	5		45	°C
V _{DD}	Positive supply voltage	5 V operation mode. Supply voltage during programming	4.5	5	5.5	V
V _{DD}	Positive supply voltage	3.3 V operation mode. Supply voltage during programming	3.3		3.5	V
I _{Prog}	Current for programming	Max current during OTP burn procedure.			100	mA

Note(s):

1. Programming parameter valid for AS5047U.

Step-by-Step Procedure to Permanently Program the Non-Volatile Memory (OTP):

The programming can either be performed in 5V operation using the internal LDO (1 μ F on regulator output pin), or in 3V Operation but using a supply voltage between 3.3V and 3.5V.

- 1. Power on cycle
- 2. Write the SETTINGS1 and SETTINGS2 and SETTINGS3 registers with the Custom settings for this application
- 3. Place the magnet at the desired zero position
- 4. Read out the measured angle from the ANGLECOM register
- 5. Write ANGLECOM [5:0] into the ZPOSL register and ANGLECOM[13:6] into the ZPOSM register
- 6. Read reg(0x0016) to reg(0x001A)
- 7. Set ECC_en in Register ECC to 1 (ECC protection enabled)
- 8. Read ECC_s (0x3FD0) to get the correct ECC key
- 9. Write ECC_s key into ECC register
- 10. Read reg(0x0016) to reg(0x001B) \rightarrow read register step1
- 11. Comparison of written content (settings and angle) with content of read register step1
- 12. If point 11 is correct, enable OTP read / write by setting PROGEN = 1 in the PROG register
- Start the OTP burn procedure by setting PROGOTP = 1 in the PROG register
- 14. Read the PROG register until it reads 0x0001 (Programming procedure complete)

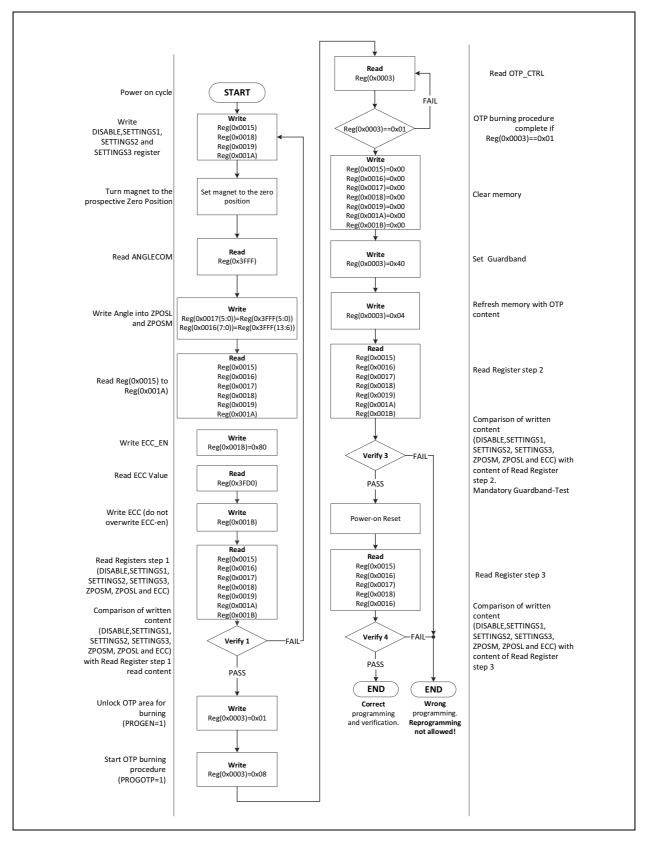
- 15. Clear the memory content by writing 0x00 in the whole non-volatile memory
- 16. Set the PROGVER = 1 to set the Guard band for the guard band test.¹
- 17. Refresh the non-volatile memory content with the OTP content by setting OTPREF = 1
- 18. Read reg(0x0016) to reg(0x001B) \rightarrow read register step2
- 19. Comparison of written content (settings and angle) with content of read register step2. If a deviation in the comparison occurs, the guard band test was not successful. Reprogramming is not allowed! Mandatory: guard band test
- 20. New power on cycle.
- 21. Read reg(0x0016) to Reg(0x001B) \rightarrow read register step3
- 22. Comparison of written content (settings and angle) with content of read register step3. If a deviation in the comparison occurs, the power on test was not successful. Reprogramming is not allowed!
- 23. If point 18 is correct, the programming was successful.

^{1.} Guard band test:

Restricted to temperature range: 25 °C \pm 20 °C

Right after the programming procedure (max. 1 hour with same conditions $25^{\circ}C \pm 20^{\circ}C$), same VDD voltage. The guard band test is only for the verification of the burned OTP fuses during the programming sequence. A use of the guard band in other cases is not allowed.

Figure 60: OTP Memory Burn and Verification Flowchart



Note(s):

1. Device with wrong programming must not be used. Scrapping mandatory.

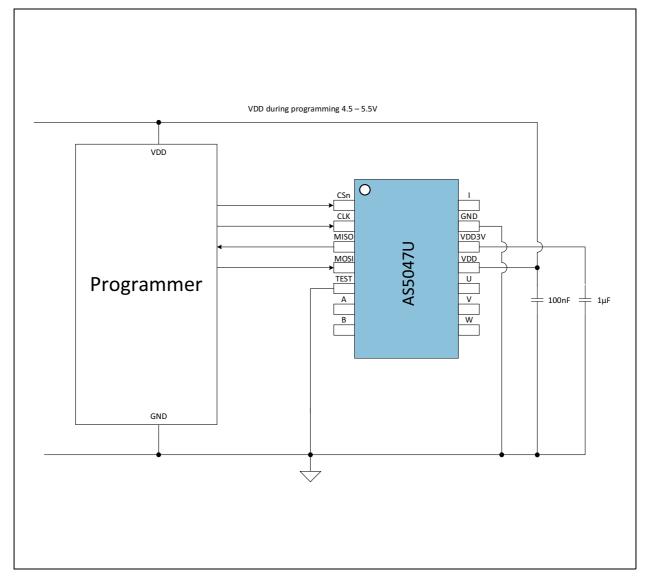
ams Datasheet [v1-01] 2020-Dec-16





Circuit Diagram

Figure 61: Minimum Circuit Diagram for the AS5047U



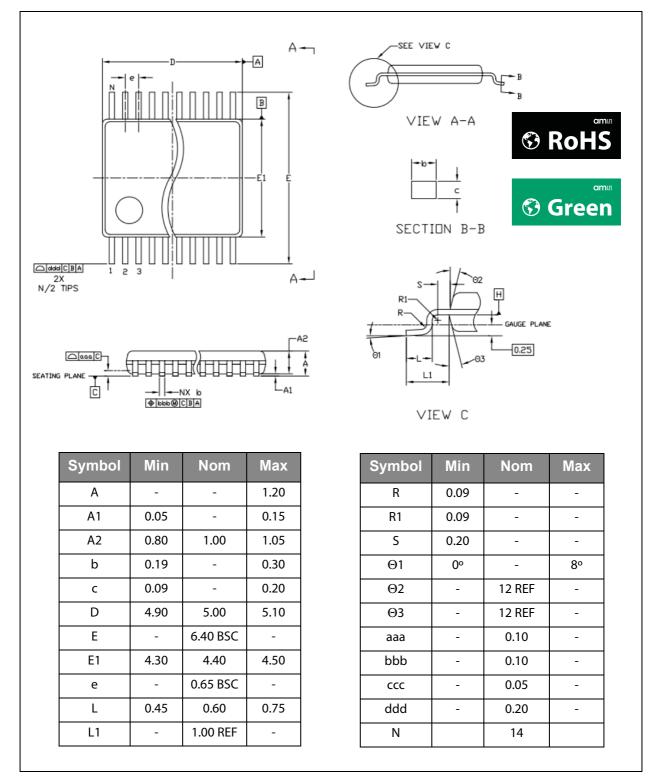
Note(s):

1. In terms of EMC and for remote application, additional protection circuit is necessary.



Package Drawings & Markings

Figure 62: Package Outline Drawing AS5047U



Note(s):

1. Dimensioning and tolerancing conform to ASME Y14.5M - 1994.

2. All dimensions are in millimeters. Angles are in degrees.

3. N is the total number of terminals.



Figure 63: AS5047U Package Marking

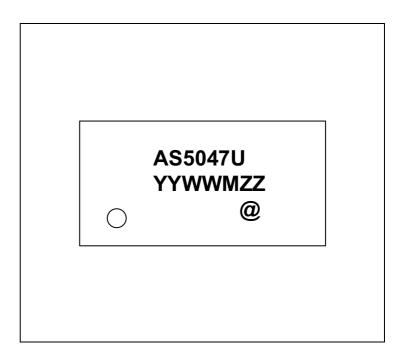


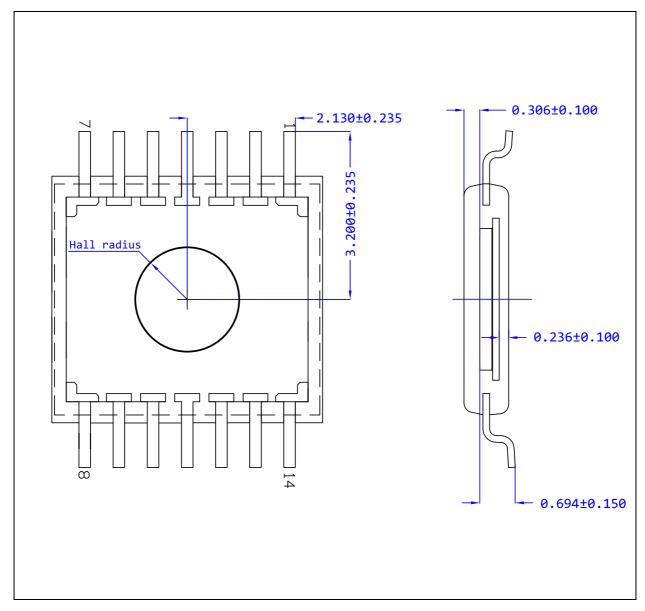
Figure 64: Packaging Code

YY	WW	М	ZZ	@
Last two digits of the manufacturing year	Manufacturing week	Plant identifier	Free choice / traceability code	Sublot identifier



Mechanical Data

Figure 65: TSSOP14 Die Placement and Hall Array Position



Note(s):

- 1. Dimensions are in mm.
- 2. The Hall array center is located in the center of the IC package. Hall array radius is 1.1mm.

3. Die thickness is 203µm nominal.



Ordering & Contact Information

Figure 66: Ordering Information

Ordering Code	Package	Marking	Delivery Form	Delivery Quantity
AS5047U-HTSM	TSSOP14	AS5047U	7" Tape & Reel in dry pack	500 pcs/reel
AS5047U-HTST	TSSOP14	AS5047U	13" Tape & Reel in dry pack	4500 pcs/reel

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Updated Figure 2	2
Updated Figure 7 and added notes under it	7
Updated Figure 19	17
Updated CRC Checksum and added Figure 31	23
Updated Figure 46	29
Updated Hysteresis and added Figure 55 and 56	36
Updated Figure 57	39
Updated Figure 58	40
Updated notes under Figure 65	47

Note(s):

1. Page and figure numbers for the previous version may differ from page and figure numbers in the current revision.

2. Correction of typographical errors is not explicitly mentioned.

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